TOSHIBA Digital Integrated Circuit Silicon Monolithic

# TC7WPN3125FK, TC7WPN3125FC

#### Low Voltage/Low Power 2-Bit Dual Supply Bus Buffer

The TC7WPN3125 is a dual supply, advanced high-speed CMOS 2-bit dual supply voltage interface bus buffer fabricated with silicon gate CMOS technology.

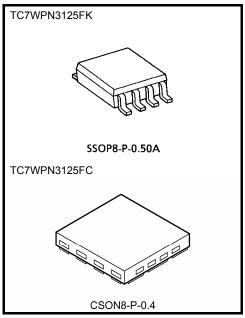
It is also designed with over voltage tolerant inputs and outputs up to  $3.6\ V.$ 

Designed for use as an interface between a 1.2-V, 1.5-V, 1.8-V, or 2.5-V bus and a 1.8-V, 2.5-V or 3.6-V bus in mixed 1.2-V, 1.5-V, 1.8-V or 2.5-V/1.8-V, 2.5-V or 3.6-V supply systems.

The A-input interfaces with the 1.2-V, 1.5-V, 1.8-V or 2.5-V bus, the B-output with the 1.8-V, 2.5-V, 3.3-V bus.

The enable input  $(\overline{OE})$  can be used to disable the device so that the signal lines are effectively isolated.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.



Weight:

SSOP8-P-0.50A: 0.01 g (typ.) CSON8-P-0.4: 0.002 g (typ.)

#### **Features**

- Level converter for interfacing 1.2-V to 1.8-V, 1.2-V to 2.5-V, 1.2-V to 3.3-V, 1.5-V to 2.5-V, 1.5-V to 3.3-V, 1.8-V to 2.5-V, 1.8-V to 3.3-V or 2.5 V to 3.3-V system.
- High-speed operation :  $t_{pd}$  = 13.7 ns (max) ( $V_{CCA}$  = 2.5 ± 0.2 V,  $V_{CCB}$  = 3.3 ± 0.3 V)

 $t_{pd}$  = 14.8 ns (max) (V<sub>CCA</sub> = 1.8 ± 0.15 V, V<sub>CCB</sub> = 3.3 ± 0.3 V)

 $t_{pd} = 16.0 \text{ ns (max) (V_{CCA} = 1.5 \pm 0.1 \text{ V}, V_{CCB} = 3.3 \pm 0.3 \text{ V})}$ 

 $t_{pd} = 29 \text{ ns (max) (V}_{CCA} = 1.2 \pm 0.1 \text{ V}, V_{CCB} = 3.3 \pm 0.3 \text{ V})$ 

 $t_{pd}$  = 18.5 ns (max) (V<sub>CCA</sub> = 1.8 ± 0.15 V, V<sub>CCB</sub> = 2.5 ± 0.2 V)

 $t_{pd} = 19.7 \text{ ns (max)} (V_{CCA} = 1.5 \pm 0.15 \text{ V}, V_{CCB} = 2.5 \pm 0.2 \text{ V})$ 

 $t_{pd} = 33 \text{ ns (max) (V}_{CCA} = 1.2 \pm 0.15 \text{ V}, V_{CCB} = 2.5 \pm 0.2 \text{ V})$ 

 $t_{pd}$  = 43 ns (max) (V<sub>CCA</sub> = 1.2 ± 0.1 V, V<sub>CCB</sub> = 1.8 ± 0.15 V)

- Output current :  $IOH / IOL = \pm 3 \text{ mA (min) (VCC} = 3.0 \text{ V)}$ 
  - $IOH / IOL = \pm 2mA$  (min) (VCC = 2.3 V)

 $IOH / IOL = \pm 0.5 \text{ mA (min) (VCC} = 1.65 \text{ V)}$ 

- Latch-up performance: -300 mA
- ESD performance: Machine model  $\geq \pm 200 \text{ V}$

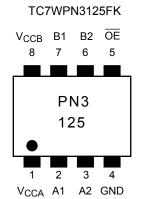
Human body model  $\geq \pm 2000 \text{ V}$ 

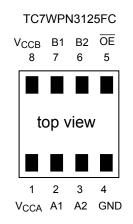
- Ultra-small package: CSON8(CST8), SSOP8(US8)
- Low current consumption: Using the new circuit significantly reduces current consumption when  $\overline{OE}$  = "H". Suitable for battery-driven applications such as PDAs and cellular phones.
- 3.6-V tolerant function and power-down protection provided on all inputs and outputs.

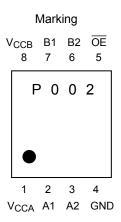
Note: Do not apply a signal to any bus pins when it is in the output mode. Damage may result.

Start of commercial production 2005-09

## Pin Assignment (top view)







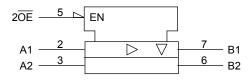
#### **Truth Table**

Inputs		Output
ŌĒ	A1, A2	B1, B2
L	L	L
L	Н	Н
Н	Х	Z

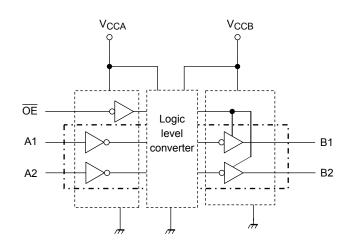
X: Don't care

Z: High impedance

## **IEC Logic Symbol**



## **Block Diagram**





#### **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Power supply voltage (Note 2)	V <sub>CCA</sub>	-0.5 to 4.6	V
(Note 2)	V <sub>CCB</sub>	-0.5 to 4.6	V
DC input voltage (An, OE)	V <sub>IN</sub>	-0.5 to 4.6	V
DC output voltage	V	-0.5 to 4.6 (Note 3)	V
(Bn)	Vout	-0.5 to V <sub>CCB</sub> + 0.5 (Note 4)	V
Input diode current	lικ	-50	mA
Output diode current	lok	±50 (Note 5)	mA
DC output current	loutb	±6	mA
DC V <sub>CC</sub> /ground current per supply pin	ICCA	±25	mA
De vergiound current per supply pin	ICCB	±50	IIIA
Power dissipation	PD	200 (SSOP8)	mW
rowei dissipation	PD	150 (CSON8)	IIIVV
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: Don't supply a voltage to V<sub>CCB</sub> pin when V<sub>CCA</sub> is in the OFF state.

Note 3: Output in OFF state

Note 4: High or Low state. IOUT absolute maximum rating must be observed.

Note 5: Vout < GND, Vout > Vcc

#### **Operating Ranges (Note 1)**

Characteristics		Symbol	Rating		Unit
Power supply voltage		$V_{CCA}$	1.1 to 2.7		V
	(Note 2)	V <sub>CCB</sub>	1.65 to 3.6		V
Input voltage (An, OE)		V <sub>IN</sub>	0 to 3.6		V
Output voltage		\/a=	0 to 3.6	(Note 3)	V
(Bn)		V <sub>OUTB</sub>	0 to V <sub>CCB</sub>	(Note 4)	V
Output ourront			±3	(Note 5)	
Output current (Bn)		I <sub>OUTB</sub>	±2	(Note 6)	mA
(611)			±0.5	(Note 7)	
Operating temperature		T <sub>opr</sub>	-40 to 85	·	°C
Input rise and fall time		dt/dv	0 to 10	(Note 8)	ns/V

Note 1: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V<sub>CC</sub> or GND.

Note 2: Don't use in V<sub>CCA</sub> > V<sub>CCB</sub>

Note 3: Output in OFF state

Note 4: High or low state

Note 5:  $V_{CCB} = 3.0 \text{ to } 3.6 \text{ V}$ 

Note 6:  $V_{CCB} = 2.3 \text{ to } 2.7 \text{ V}$ 

Note 7:  $V_{CCB} = 1.65 \text{ to } 1.95 \text{ V}$ 

Note 8:  $V_{IN} = 0.8$  to 2.0 V,  $V_{CCA} = 2.5$  V,  $V_{CCB} = 3.0$  V



## **Electrical Characteristics**

# DC Characteristics (1.1 V $\leq$ V<sub>CCA</sub> $\leq$ 2.7 V , 1.65 V $\leq$ V<sub>CCB</sub> $\leq$ 3.6 V)

	0	Test Condition		V 00		Ta = -40	) to 85°C	1.124									
Characteristics	Symbol	rest	Condition	V <sub>CCA</sub> (V)	V <sub>CCB</sub> (V)	Min	Max	Unit									
				1.1≤V <sub>CCA</sub> <1.4	1.65 to 3.6	0.65× V <sub>CCA</sub>	_	V									
H-level input voltage	V <sub>IHA</sub>	V <sub>IN</sub>		1.4≤V <sub>CCA</sub> <1.65	1.65 to 3.6	0.65 × V <sub>CCA</sub>	_	V									
				1.65≤V <sub>CCA</sub> <2.3	2.3 to 3.6	0.65 × V <sub>CCA</sub>	_	V									
					2.7 to 3.6	1.6	_	V									
				1.1≤V <sub>CCA</sub> <1.4	1.65 to 3.6		0.30 × V <sub>CCA</sub>	V									
L-level input voltage	$V_{ILA}$	V <sub>IN</sub>		1.4≤V <sub>CCA</sub> <1.65	1.65 to 3.6	_	0.30 × V <sub>CCA</sub>	V									
				1.65≤V <sub>CCA</sub> <2.3	2.3 to 3.6	_	0.35 × V <sub>CCA</sub>	V									
				2.3≤V <sub>CCA</sub> ≤2.7	2.7 to 3.6	_	0.7	V									
	H-level output voltage $V_{OHB}$ $A_n = V_{IH}$	I <sub>OHB</sub> = -100 μA	1.1 to 2.7	1.65 to 3.6	V <sub>CCB</sub> – 0.2	_											
H-level output voltage		$V_{IN}$ $A_{n} = V_{IH}$ $A_{n} = V_{IL}$	$I_{OHB} = -0.5mA$	1.1 to 1.65	1.65	1.25	_	٧									
			$I_{OHB} = -2 \text{ mA}$	1.1 to 2.3	2.3	1.7	_										
			$I_{OHB} = -3 \text{ mA}$	1.1 to 2.7	3.0	2.2	_										
			I <sub>OLB</sub> = 100 μA	1.1 to 2.7	1.65 to 3.6	_	0.2										
L lovel output voltage	\/a. =	A	Λ \/	Λ \/	Δ \/	Λ \/	۸ ۷	Λ \/	۸ ۱/	A., - VII	Δ – \/u	$I_{OLB} = 0.5 \text{ mA}$	1.1 to 1.65	1.65	_	0.3	V
L-level output voltage	$V_{OLB}$	An = VIL	I <sub>OLB</sub> = 2 mA	1.1 to 2.3	2.3	_	0.6	v									
			I <sub>OLB</sub> = 3 mA	1.1 to 2.7	3.0	_	0.55										
3-state output OFF state current	I <sub>OZB</sub>			1.1 to 2.7	1.65 to 3.6	_	±2.0	μА									
Input leakage current	I <sub>IN</sub>	$V_{IN} = 0 \text{ to } 3.6$	V	1.1 to 2.7	1.65 to 3.6	_	±1.0	μΑ									
	I <sub>OFF1</sub>	$V_{IN}$ , $B_n = 0$ to	3.6 V	0	0	_	2.0										
Power-off leakage current	I <sub>OFF2</sub>	$\overline{OE} = V_{CCA}$		1.1 to 2.7	0	_	2.0	μΑ									
	I <sub>OFF3</sub>	$A_n$ , $B_n = 0$ to	3.6 V	1.1 to 2.7	OPEN	_	2.0										
	ICCA	V <sub>IN</sub> = V <sub>CCA</sub> o	r GND	1.1 to 2.7	1.65 to 3.6	_	2.0										
	I <sub>CCB</sub>	V <sub>IN</sub> = V <sub>CCA</sub> o	r GND	1.1 to 2.7	1.65 to 3.6	_	2.0										
Quiescent supply current	I <sub>CCA</sub>	$V_{CCA} < V_{IN} \le$	3.6 V	1.1 to 2.7	1.65 to 3.6	_	±2.0	μΑ									
	I <sub>CCB</sub>	$V_{IN}=V_{CCA}$ $V_{CCB} \le B_n \le 3$	3.6 V	1.1 to 2.7	1.65 to 3.6	_	±2.0										



## AC Characteristics (Ta = -40 to 85°C, Input: $t_r = t_f = 2.0$ ns)

 $V_{CCA} = 2.5 \pm 0.2$  V,  $V_{CCB} = 3.3 \pm 0.3$  V

Characteristics	Symbol	Test Condition	Min	Max	Unit
Propagation delay time $(An \to Bn)$	t <sub>pLH</sub>	Figure 1, Figure 2	1.0	13.7	
3-state output enable time $(\overline{\sf OE} \to {\sf Bn})$	t <sub>pZL</sub>	Figure 1, Figure 3	1.0	16.6	ns
3-state output disable time $(\overline{OE} \rightarrow Bn)$	t <sub>pLZ</sub>	Figure 1, Figure 3	1.0	7.2	
Output to output skew	t <sub>osLH</sub>	(Note)	_	0.5	ns

Note: Parameter guaranteed by design.

 $(t_{OSLH} = |t_{DLHm} - t_{DLHn}|, t_{OSHL} = |t_{DHLm} - t_{DHLn}|)$ 

#### $V_{CCA} = 1.8 \pm 0.15 \text{ V}, V_{CCB} = 3.3 \pm 0.3 \text{ V}$

Characteristics	Symbol	Test Condition	Min	Max	Unit
Propagation delay time $ (An \rightarrow Bn) $	t <sub>pLH</sub> t <sub>pHL</sub>	Figure 1, Figure 2	1.0	14.8	
3-state output enable time $(\ \overline{\text{OE}} \ \to \text{Bn})$	t <sub>pZL</sub> t <sub>pZH</sub>	Figure 1, Figure 3	1.0	18.9	ns
3-state output disable time ( $\overrightarrow{OE} \rightarrow Bn$ )	t <sub>pLZ</sub>	Figure 1, Figure 3	1.0	8.7	
Output to output skew	t <sub>osLH</sub>	(Note)		0.5	ns

Note: Parameter guaranteed by design.

 $(t_{OSLH} = |t_{pLHm} - t_{pLHn}|, t_{OSHL} = |t_{pHLm} - t_{pHLn}|)$ 

## $V_{CCA} = 1.5 \pm 0.1 \text{ V}, V_{CCB} = 3.3 \pm 0.3 \text{ V}$

Characteristics	Symbol	Test Condition	Min	Max	Unit
Propagation delay time $ (An \rightarrow Bn) $	t <sub>pLH</sub> t <sub>pHL</sub>	Figure 1, Figure 2	1.0	16.0	
3-state output enable time ( OE → Bn)	t <sub>pZL</sub>	Figure 1, Figure 3	1.0	22.8	ns
3-state output disable time ( OE → Bn)	t <sub>pLZ</sub>	Figure 1, Figure 3	1.0	10.2	
Output to output skew	t <sub>osLH</sub>	(Note)	_	1.5	ns

5

Note: Parameter guaranteed by design.

 $(t_{OSLH} = |t_{PLHm} - t_{PLHn}|, t_{OSHL} = |t_{PHLm} - t_{PHLn}|)$ 

# $V_{CCA} = 1.2 \pm 0.1$ V, $V_{CCB} = 3.3 \pm 0.3$ V

Characteristics	Symbol	Test Condition	Min	Max	Unit
Propagation delay time $(An \to Bn)$	t <sub>pLH</sub>	Figure 1, Figure 2	1.0	29	
3-state output enable time $(\overline{OE}\to Bn)$	t <sub>pZL</sub> t <sub>pZH</sub>	Figure 1, Figure 3	1.0	63	ns
3-state output disable time ( OE → Bn)	t <sub>pLZ</sub>	Figure 1, Figure 3	1.0	23	
Output to output skew	t <sub>osLH</sub>	(Note)		1.5	ns

Note: Parameter guaranteed by design.

 $(t_{OSLH} = |t_{PLHm} - t_{PLHn}|, t_{OSHL} = |t_{PHLm} - t_{PHLn}|)$ 

## $V_{CCA} = 1.8 \pm 0.15$ V, $V_{CCB} = 2.5 \pm 0.2$ V

Characteristics	Symbol	Test Condition	Min	Max	Unit
Propagation delay time $(An \to Bn)$	t <sub>pLH</sub>	Figure 1, Figure 2	1.0	18.5	
3-state output enable time $(\ \overline{OE} \ \to Bn)$	t <sub>pZL</sub> t <sub>pZH</sub>	Figure 1, Figure 3	1.0	23.6	ns
3-state output disable time $(\overline{OE} \rightarrow Bn)$	t <sub>pLZ</sub>	Figure 1, Figure 3	1.0	6.9	
Output to output skew	t <sub>osLH</sub>	(Note)		0.5	ns

Note: Parameter guaranteed by design.

 $(t_{OSLH} = |t_{pLHm} - t_{pLHn}|, \, t_{OSHL} = |t_{pHLm} - t_{pHLn}|)$ 

## $V_{CCA} = 1.5 \pm 0.1$ V, $V_{CCB} = 2.5 \pm 0.2$ V

Characteristics	Symbol	Test Condition	Min	Max	Unit
Propagation delay time $(\text{An} \rightarrow \text{Bn})$	t <sub>pLH</sub> t <sub>pHL</sub>	Figure 1, Figure 2	1.0	19.7	
3-state output enable time $(\ \overline{OE} \ \to Bn)$	t <sub>pZL</sub> t <sub>pZH</sub>	Figure 1, Figure 3	1.0	26.6	ns
3-state output disable time $(\overline{OE} \to Bn)$	t <sub>pLZ</sub>	Figure 1, Figure 3	1.0	8.3	
Output to output skew	t <sub>osLH</sub>	(Note)	_	1.5	ns

6

Note: Parameter guaranteed by design.

 $(t_{OSLH} = |t_{pLHm} - t_{pLHn}|, t_{OSHL} = |t_{pHLm} - t_{pHLn}|)$ 

# $V_{CCA} = 1.2 \pm 0.1$ V, $V_{CCB} = 2.5 \pm 0.2$ V

Characteristics	Symbol	Test Condition	Min	Max	Unit
Propagation delay time $(An \to Bn)$	t <sub>pLH</sub>	Figure 1, Figure 2	1.0	33	
3-state output enable time $( \overrightarrow{OE} \ \to Bn)$	t <sub>pZL</sub>	Figure 1, Figure 3	1.0	66	ns
3-state output disable time ( OE → Bn)	t <sub>pLZ</sub>	Figure 1, Figure 3	1.0	20	
Output to output skew	t <sub>osLH</sub>	(Note)	_	1.5	ns

Note: Parameter guaranteed by design.

 $(t_{OSLH} = |t_{pLHm} - t_{pLHn}|, \, t_{OSHL} = |t_{pHLm} - t_{pHLn}|)$ 

 $V_{CCA} = 1.2 \pm 0.1$  V,  $V_{CCB} = 1.8 \pm 0.15$  V

Characteristics	Symbol	Test Condition	Min	Max	Unit
Propagation delay time $(\text{An} \rightarrow \text{Bn})$	t <sub>pLH</sub>	Figure 1, Figure 2	1.0	43	
3-state output enable time $(\ \overline{OE} \ \to Bn)$	t <sub>pZL</sub>	Figure 1, Figure 3	1.0	78	ns
3-state output disable time $(\overline{OE} \rightarrow Bn)$	t <sub>pLZ</sub>	Figure 1, Figure 3	1.0	20	
Output to output skew	t <sub>osLH</sub>	(Note)	_	1.5	ns

Note: Parameter guaranteed by design.

 $(t_{OSLH} = |t_{pLHm} - t_{pLHn}|, \, t_{OSHL} = |t_{pHLm} - t_{pHLn}|)$ 

## **Capacitive Characteristics (Ta = 25°C)**

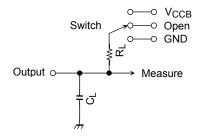
Characteristics		Symbol	Test Circuit			Тур.	Unit
Characteristics		Symbol	rest circuit	V <sub>CCA</sub> (V)	V <sub>CCB</sub> (V)		
Input capacitance		C <sub>IN</sub>	An, $\overline{\text{OE}}$	2.5	3.3	7	pF
Output capacitance		C <sub>OUT</sub>	Bn	2.5	3.3	8	pF
Power dissipation capacitance	(Note) C <sub>PDB</sub>	C <sub>PDA</sub>	<u>OE</u> ="L"	2.5	3.3	3	
			ŌĒ ="H"	2.5	3.3	0	- pF
		C	OE ="L"	2.5	3.3	13	
		CADB	OE ="H"	2.5	3.3	0	

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/2 (per bit)$ 

#### **AC Test Circuit**



Parameter	Switch	
t <sub>pLH</sub> , t <sub>pHL</sub>	Open	
t <sub>pLZ</sub> , t <sub>pZL</sub>	V <sub>CCB</sub>	
t <sub>pHZ</sub> , t <sub>pZH</sub>	GND	

Symbol	V <sub>CCB</sub> (output)			
	$\begin{array}{c} 3.3\pm0.3~\textrm{V} \\ 2.5\pm0.2~\textrm{V} \end{array}$	1.8 ± 0.15 V		
RL	1 kΩ	1 kΩ		
CL	30 pF	30 pF		

Figure 1

8

#### **AC Waveform**

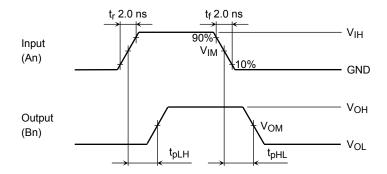


Figure 2 t<sub>pLH</sub>, t<sub>pHL</sub>

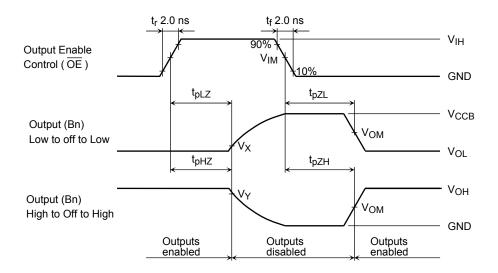
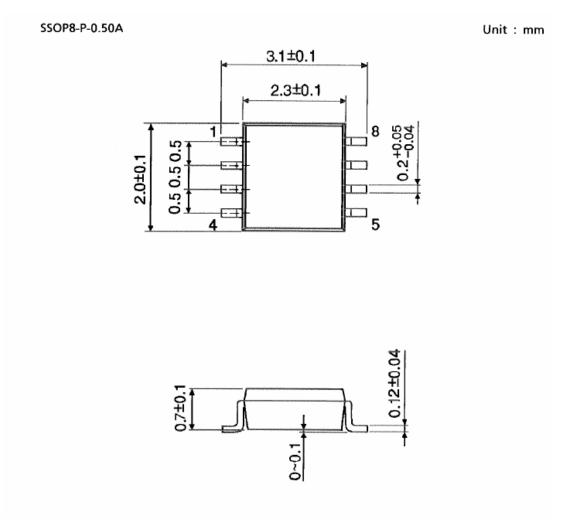


Figure 3  $t_{pLZ}$ ,  $t_{pHZ}$ ,  $t_{pZL}$ ,  $t_{pZH}$ 

	Symbol	V <sub>CCA</sub> , V <sub>CCB</sub>			
		22 - 027	$2.5\pm0.2~\textrm{V}$	$1.5\pm0.1~\text{V}$	
		$3.3\pm0.3~\text{V}$	1.8 ± 0.15 V	$1.2\pm0.1~\textrm{V}$	
Input	V <sub>IH</sub>	-	V <sub>CCA</sub>	$V_{CCA}$	
	V <sub>IM</sub>	-	V <sub>CCA</sub> /2	V <sub>CCA</sub> /2	
Output	V <sub>OM</sub>	V <sub>OH</sub> /2	V <sub>OH</sub> /2	-	
	VX	V <sub>OL</sub> + 0.3 V	V <sub>OL</sub> + 0.15 V	-	
	V <sub>Y</sub>	V <sub>OH</sub> – 0.3 V	V <sub>OH</sub> – 0.15 V	-	

9

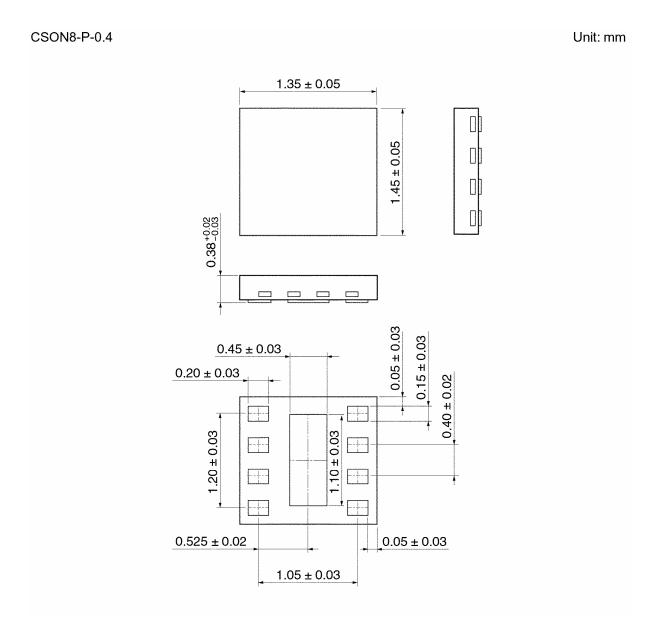
# **Package Dimensions**



weight: 0.01 g (typ.)



# **Package Dimensions**



11

Weight: 0.002 g (typ.)

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12